

Transaction Information

Tool ID	CT02
Tool Status	Running Wafers
Location	East Fishkill, USA
Wafer Size	300 mm
Fab Section	Diffusion
Tool Available Date	2025-04-01

General Product Information

Vendor Supplier	ULTRATECH
Model	LSA100A
Vintage	2008
Serial No	6125
Asset Description	ULTRATECH LASER ANNEAL CT02
Software Version	Standard
CIM	SECS GEM
Process	Laser Anneal

Hardware Configuration (Fab)

System Type	Description	Quantity	Status
Main System	Main Tool	1	OK
Handler System	Standard	1	OK
Factory Interface	FOUP	2	OK
Options System			

Hardware Configuration (Subfab / Auxilliary Units)

Description	Quantity	Status
NONE		

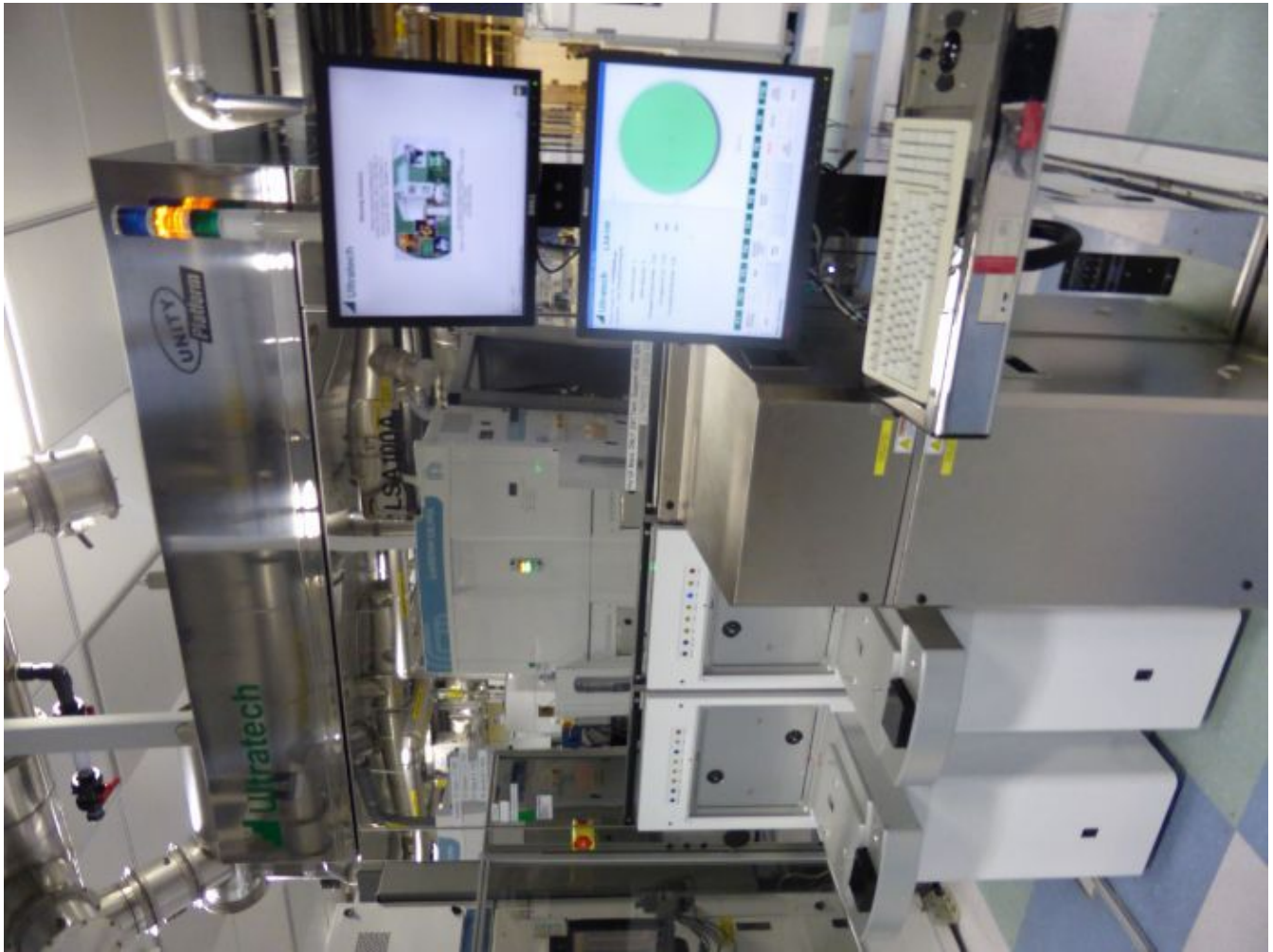
Missing/Faulty Parts / Accesories List

Description	Quantity
NONE	

Tool Pictures

General

Main tool

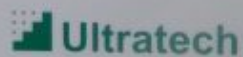


RASCO CO.,LTD.

Telephone 0480(72)8877 MADE IN JAPAN

Model No.	: TBW-UP 10C
Serial No.	: UP 10C803009
Voltage/Phase/Hz	: 208VAC, 3-phase, 50/60Hz
Full Load	: 120 AMP (Laser 55A, Chamber 65A)
Largest Load	: 43.2 kVA (Laser 19.8kVA, Chamber 23.4kVA)
Overcurrent Protection	: 150 AMP
IC (Interrupt Capacity)	: 85 kA
Refrigerant Charge	: HFC:R407C/4.0Kg
Wiring Configuration	: 4Wire+Ground
Electrical Schematic No.	: CL 1-0032B001-011 Rev. 03
Customer No.	: 18-25-04803-01 Rev. D
Mfg Date	: 26 Mar 2008

OVERCURRENT PROTECTION PROVIDED
AT MACHINE SUPPLY TERMINALS



Ultratech, Inc.
3050 Zanker Road
San Jose, CA 95134

Model:

LSA100A

Manufactured:

May 2008

This product complies with all applicable requirements
of 21 CFR 1040.10 and 1040.11 except for deviations
pursuant to Laser Notice No. 50, dated July 2001.



